

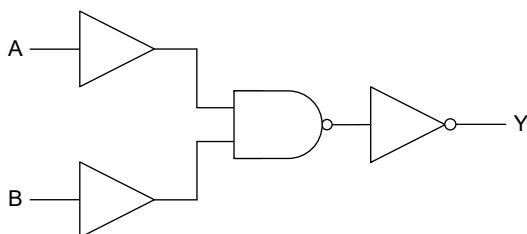
GENERAL DESCRIPTION

The 74AUP1G08 is a low power single 2-input positive-AND gate which can accept supply voltage range from 0.8V to 3.6V. All of the inputs support Schmitt-trigger action. The device features low static power dissipation over the wide supply voltage range and implements Boolean function $Y = A \cdot B$ or $Y = \overline{A} + \overline{B}$.

This device is highly suitable for partial power-down applications by using power-off leakage current (I_{OFF}) circuit. When the device is powered down, the output is disabled, and the current backflow can be prevented from passing through the device.

The 74AUP1G08 is available in Green SC70-5, SOT-23-5, XTDFN-0.8×0.8-4AL, XTDFN-1×1-6L and UTDFN-1.45×1-6AL packages. It operates over an ambient temperature range of -40°C to +125°C.

LOGIC DIAGRAM



FEATURES

- Wide Supply Voltage Range: 0.8V to 3.6V
- Inputs Accept Voltages Higher than the Supply Voltage
- +4mA/-4mA Output Current
- Low Static Power Dissipation: $I_{CC} = 0.1\mu A$ (TYP)
- Low Dynamic-Power Dissipation: $C_{PD} = 6.5\text{pF}$ (TYP) at $V_{CC} = 3.3V$
- All Inputs with Schmitt-Trigger
- Support Partial Power-Down Mode
- -40°C to +125°C Operating Temperature Range
- Available in Green SC70-5, SOT-23-5, XTDFN-0.8×0.8-4AL, XTDFN-1×1-6L and UTDFN-1.45×1-6AL Packages

APPLICATIONS

Computing
Tablet PC
Server
Telecom Equipment
Industrial Equipment
Medical Equipment
Smart Phone
Wearable Device

FUNCTION TABLE

INPUT		OUTPUT
A	B	Y
H	H	H
L	X	L
X	L	L

$$Y = A \cdot B \text{ or } Y = \overline{A} + \overline{B}$$

H = High Voltage Level

L = Low Voltage Level

X = Don't Care

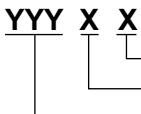
PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
74AUP1G08	SC70-5	-40°C to +125°C	74AUP1G08XC5G/TR	08GXX	Tape and Reel, 3000
	SOT-23-5	-40°C to +125°C	74AUP1G08XN5G/TR	08JXX	Tape and Reel, 3000
	XTDFN-0.8×0.8-4AL	-40°C to +125°C	74AUP1G08XXGO4G/TR	0X	Tape and Reel, 10000
	XTDFN-1×1-6L	-40°C to +125°C	74AUP1G08XXDM6G/TR	2X	Tape and Reel, 10000
	UTDFN-1.45×1-6AL	-40°C to +125°C	74AUP1G08XUDL6G/TR	0PX	Tape and Reel, 5000

MARKING INFORMATION

NOTE: XX = Date Code. X = Date Code.

SC70-5/SOT-23-5



XTDFN-0.8×0.8-4AL/XTDFN-1×1-6L



UTDFN-1.45×1-6AL



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

Supply Voltage Range, V _{CC}	-0.5V to 4.6V
Input Voltage Range, V _I ⁽²⁾	-0.5V to 4.6V
Output Voltage Range, V _O ⁽²⁾	
Active Mode or Power-Off State	-0.5V to 4.6V
Input Clamp Current, I _{IK} (V _I < 0V)	-50mA
Output Clamp Current, I _{OK} (V _O < 0V)	-50mA
Continuous Output Current, I _O	±20mA
Continuous Current through V _{CC} or GND	±50mA
Junction Temperature ⁽³⁾	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM	7000V
CDM	1000V

RECOMMENDED OPERATING CONDITIONS

Supply Voltage Range, V _{CC}	0.8V to 3.6V
Input Voltage Range, V _I ⁽⁴⁾	0V to 3.6V
Output Voltage Range, V _O	
Active Mode	0V to V _{CC}
Power-Off State	0V to 3.6V
Output Current, I _O	±4mA
Input Transition Rise or Fall Rate, Δt/ΔV	200ns/V (MAX)
Operating Temperature Range	-40°C to +125°C

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

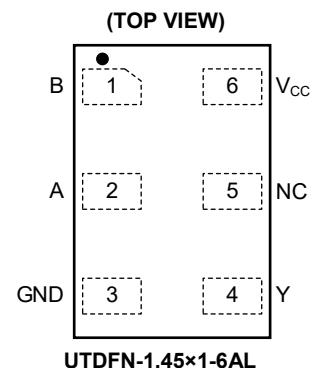
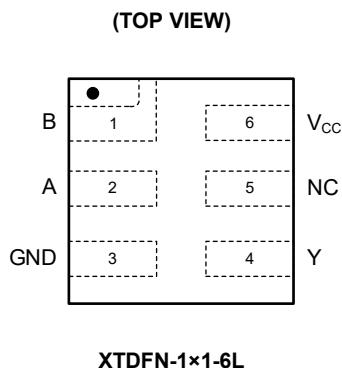
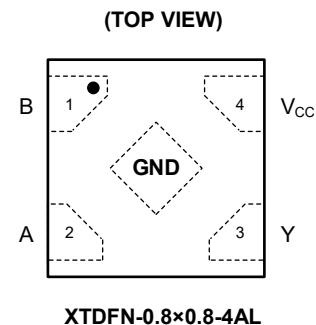
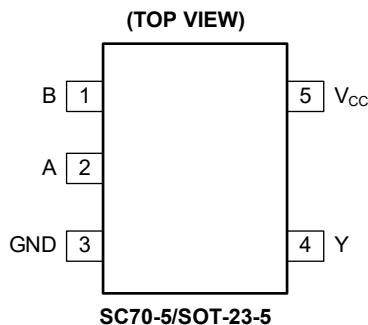
OVERSTRESS CAUTION

- Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.
- The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.
- The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.
- Unused input pins must be held at V_{CC} or GND to guarantee the device in normal operation.

ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

PIN CONFIGURATIONS



PIN DESCRIPTION

PIN			NAME	FUNCTION
SC70-5/SOT-23-5	XTDFN-0.8x0.8-4AL	XTDFN-1x1-6L/ UTDFN-1.45x1-6AL		
1	1	1	B	Data Input.
2	2	2	A	Data Input.
3	—	3	GND	Ground.
4	3	4	Y	Data Output.
—	—	5	NC	No Connection.
5	4	6	V _{CC}	Supply Voltage.
—	Exposed Pad	—	GND	Ground.

ELECTRICAL CHARACTERISTICS(Full = -40°C to +125°C, all typical values are measured at T_A = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
High-Level Input Voltage	V _{IH}	V _{CC} = 0.8V	Full	0.70 × V _{CC}			V
		V _{CC} = 0.9V to 1.95V	Full	0.65 × V _{CC}			
		V _{CC} = 2.3V to 2.7V	Full	1.6			
		V _{CC} = 3.0V to 3.6V	Full	2.0			
Low-Level Input Voltage	V _{IL}	V _{CC} = 0.8V	Full			0.30 × V _{CC}	V
		V _{CC} = 0.9V to 1.95V	Full			0.30 × V _{CC}	
		V _{CC} = 2.3V to 2.7V	Full			0.7	
		V _{CC} = 3.0V to 3.6V	Full			0.9	
High-Level Output Voltage	V _{OH}	V _{CC} = 0.8V to 3.6V, I _{OH} = -20µA	Full	V _{CC} - 0.1	V _{CC} - 0.01		V
		V _{CC} = 1.1V, I _{OH} = -1.1mA	Full	0.7 × V _{CC}	0.99		
		V _{CC} = 1.4V, I _{OH} = -1.7mA	Full	1.03	1.28		
		V _{CC} = 1.65V, I _{OH} = -1.9mA	Full	1.30	1.54		
		V _{CC} = 2.3V, I _{OH} = -2.3mA	Full	1.97	2.19		
		V _{CC} = 2.3V, I _{OH} = -3.1mA	Full	1.85	2.15		
		V _{CC} = 3.0V, I _{OH} = -2.7mA	Full	2.67	2.89		
		V _{CC} = 3.0V, I _{OH} = -4.0mA	Full	2.55	2.84		
Low-Level Output Voltage	V _{OL}	V _{CC} = 0.8V to 3.6V, I _{OL} = 20µA	Full		0.01	0.10	V
		V _{CC} = 1.1V, I _{OL} = 1.1mA	Full		0.09	0.3 × V _{CC}	
		V _{CC} = 1.4V, I _{OL} = 1.7mA	Full		0.10	0.37	
		V _{CC} = 1.65V, I _{OL} = 1.9mA	Full		0.10	0.35	
		V _{CC} = 2.3V, I _{OL} = 2.3mA	Full		0.10	0.33	
		V _{CC} = 2.3V, I _{OL} = 3.1mA	Full		0.14	0.45	
		V _{CC} = 3.0V, I _{OL} = 2.7mA	Full		0.11	0.33	
		V _{CC} = 3.0V, I _{OL} = 4.0mA	Full		0.16	0.45	
Input Leakage Current	I _I	A or B input, V _{CC} = 0V to 3.6V, V _I = GND to 3.6V	Full		±0.01	±0.5	µA
Power-Off Leakage Current	I _{OFF}	V _{CC} = 0V, V _I or V _O = 0V to 3.6V	Full		±0.01	±0.5	µA
Additional Power-Off Leakage Current	ΔI _{OFF}	V _{CC} = 0V to 0.2V, V _I or V _O = 0V to 3.6V	Full		±0.01	±0.6	µA
Supply Current	I _{CC}	V _{CC} = 0.8V to 3.6V, V _I = GND or V _{CC} to 3.6V, I _O = 0A	Full		0.1	0.9	µA
Additional Supply Current	ΔI _{CC}	One input at V _{CC} - 0.6V, other input at V _{CC} or GND, V _{CC} = 3.3V, V _I = V _{CC} - 0.6V, I _O = 0A	Full		1	50	µA
Input Capacitance	C _I	V _{CC} = 0V, V _I = V _{CC} or GND	+25°C		5		pF
		V _{CC} = 3.6V, V _I = V _{CC} or GND	+25°C		5		
Output Capacitance	C _O	V _{CC} = 0V, V _O = GND	+25°C		4.5		pF

DYNAMIC CHARACTERISTICS(See Figure 1 for test circuit. Full = -40°C to +125°C, all typical values are measured at T_A = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN ⁽¹⁾	TYP	MAX ⁽¹⁾	UNITS
Propagation Delay ⁽²⁾	t _{PD}	A or B to Y, C _L = 30pF	V _{CC} = 0.8V	Full		37.0	
			V _{CC} = 1.2V ± 0.1V	Full	1.0	13.5	38.5
			V _{CC} = 1.5V ± 0.1V	Full	0.5	9.0	16.9
			V _{CC} = 1.8V ± 0.15V	Full	0.5	7.0	13.5
			V _{CC} = 2.5V ± 0.2V	Full	0.5	5.0	9.4
			V _{CC} = 3.3V ± 0.3V	Full	0.5	4.5	7.5
Power Dissipation Capacitance ⁽³⁾	C _{PD}	f = 10MHz	V _{CC} = 0.8V	+25°C		6.5	
			V _{CC} = 1.2V ± 0.1V	+25°C		6.5	
			V _{CC} = 1.5V ± 0.1V	+25°C		6.5	
			V _{CC} = 1.8V ± 0.15V	+25°C		6.5	
			V _{CC} = 2.5V ± 0.2V	+25°C		6.5	
			V _{CC} = 3.3V ± 0.3V	+25°C		6.5	

NOTES:

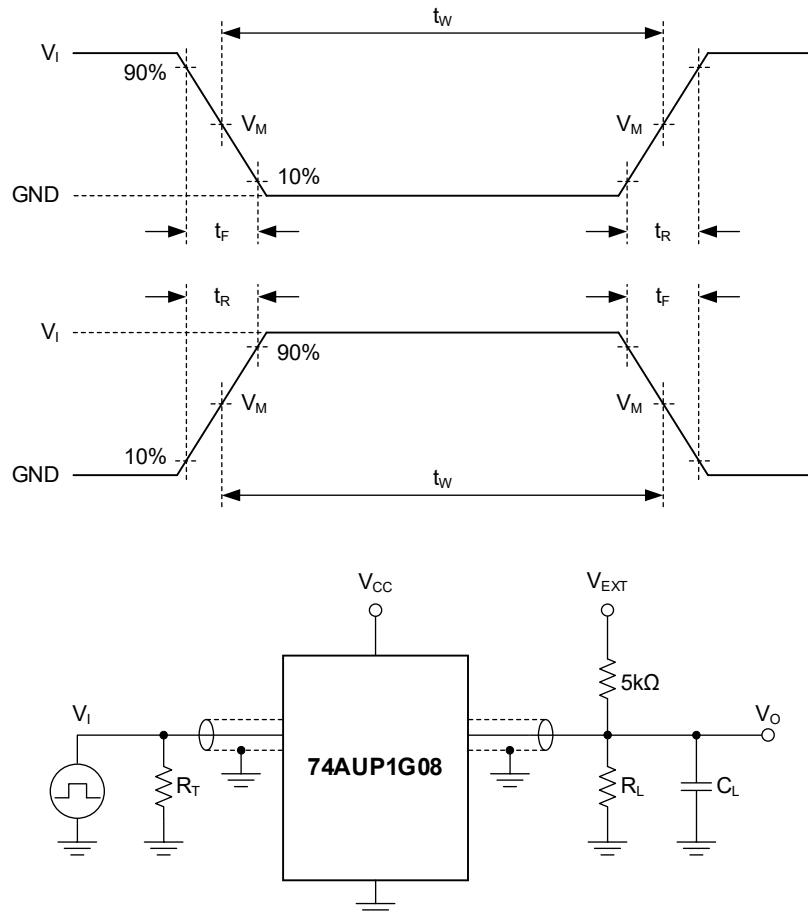
1. Specified by design and characterization, not production tested.
2. t_{PD} is the same as t_{PLH} and t_{PHL}.
3. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$$

where:

 - f_i = Input frequency in MHz.
 - f_o = Output frequency in MHz.
 - C_L = Output load capacitance in pF.
 - V_{CC} = Supply voltage in Volts.
 - N = Number of inputs switching.
 - $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = Sum of the outputs.

TEST CIRCUIT



Test conditions are given in Table 1.

Definitions for test circuit:

R_L : Load resistance.

C_L : Load capacitance (includes jig and probe).

R_T : Termination resistance (equals to output impedance Z_O of the pulse generator).

V_{EXT} : External voltage is used to measure switching time.

Figure 1. Test Circuit for Measuring Switching Times

Table 1. Test Conditions

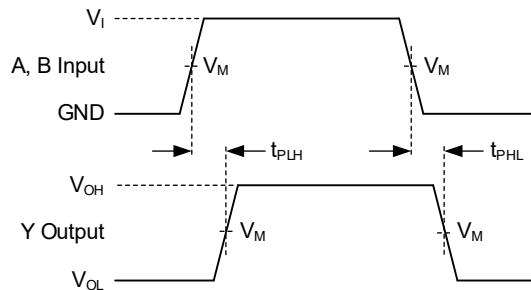
SUPPLY VOLTAGE	INPUT		LOAD		V _{EXT}		
V _{CC}	V _I	t _R , t _F	C _L	R _L ⁽¹⁾⁽²⁾	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}	t _{PZL} , t _{PLZ}
0.8V to 3.6V	V _{CC}	≤ 3.0ns	30pF	5kΩ, 1MΩ	Open	GND	2 × V _{CC}

NOTES:

1. $R_L = 5\text{k}\Omega$ is used to measure enable and disable times.

2. $R_L = 1\text{M}\Omega$ is used to measure propagation delays, setup and hold times and pulse width.

WAVEFORMS



Test conditions are given in Table 1.

Measurement points are given in Table 2.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 2. Input (A, B) to Output (Y) Propagation Delay Times

Table 2. Measurement Points

SUPPLY VOLTAGE	INPUT		OUTPUT
V_{CC}	V_I	$V_M^{(1)}$	V_M
0.8V to 3.6V	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$

NOTE:

1. The measurement points should be V_{IH} or V_{IL} when the input rising or falling time exceeds 3.0ns.

REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Original (DECEMBER 2023) to REV.A

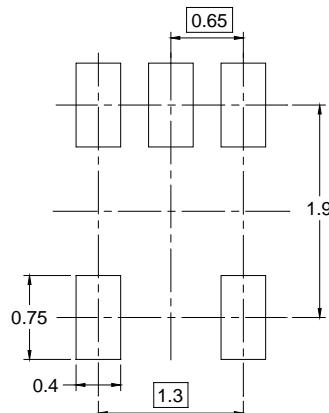
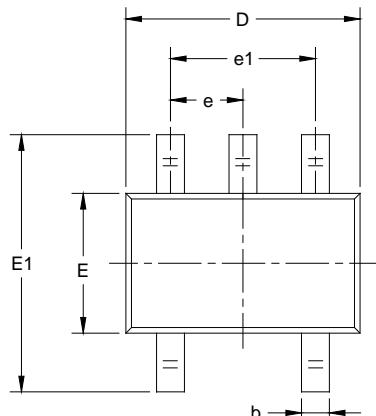
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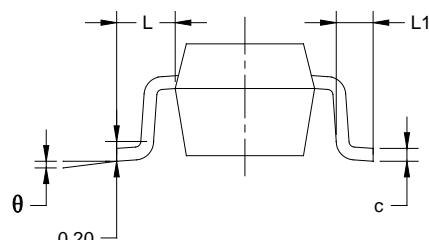
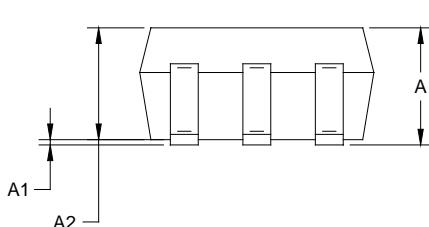
PACKAGE INFORMATION

PACKAGE OUTLINE DIMENSIONS

SC70-5



RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.800	1.100	0.031	0.043
A1	0.000	0.100	0.000	0.004
A2	0.800	1.000	0.031	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.220	0.003	0.009
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.65 TYP		0.026 TYP	
e1	1.300 BSC		0.051 BSC	
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

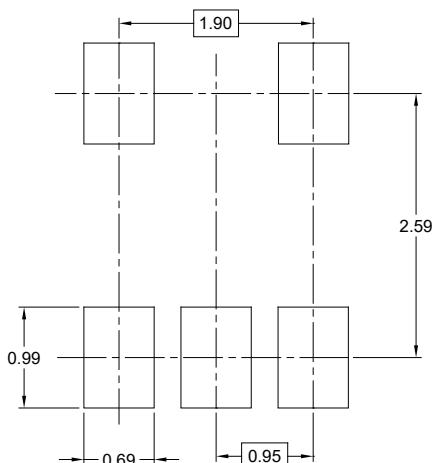
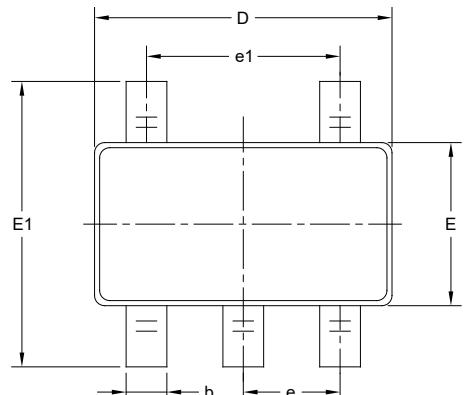
NOTES:

1. Body dimensions do not include mode flash or protrusion.
2. This drawing is subject to change without notice.

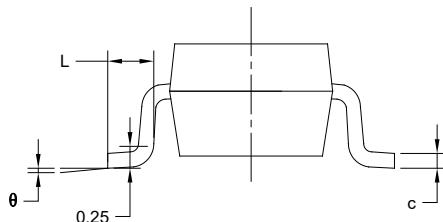
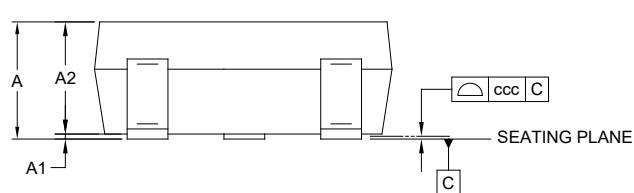
PACKAGE INFORMATION

PACKAGE OUTLINE DIMENSIONS

SOT-23-5



RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		
	MIN	MOD	MAX
A	-	-	1.450
A1	0.000	-	0.150
A2	0.900	-	1.300
b	0.300	-	0.500
c	0.080	-	0.220
D	2.750	-	3.050
E	1.450	-	1.750
E1	2.600	-	3.000
e	0.950 BSC		
e1	1.900 BSC		
L	0.300	-	0.600
θ	0°	-	8°
ccc	0.100		

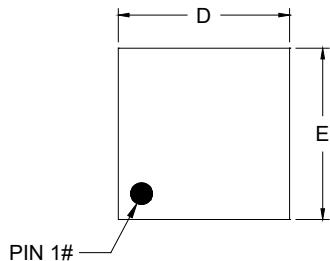
NOTES:

1. This drawing is subject to change without notice.
2. The dimensions do not include mold flashes, protrusions or gate burrs.
3. Reference JEDEC MO-178.

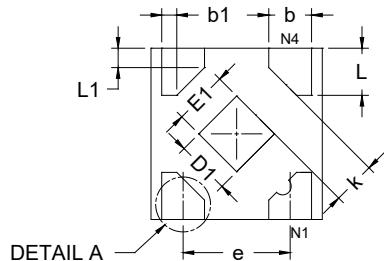
PACKAGE INFORMATION

PACKAGE OUTLINE DIMENSIONS

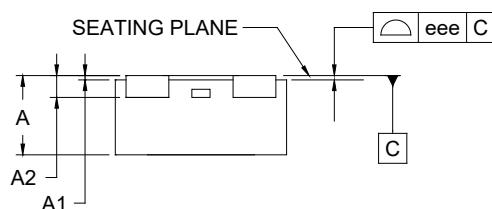
XTDFN-0.8×0.8-4AL



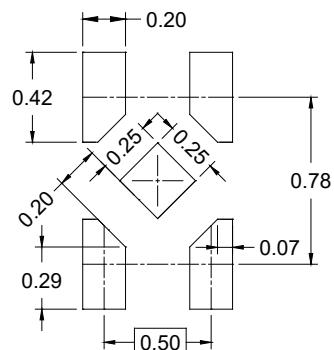
TOP VIEW



BOTTOM VIEW



SIDE VIEW



ALTERNATE A-1 ALTERNATE A-2

DETAIL A
ALTERNATE TERMINAL
CONSTRUCTION

RECOMMENDED LAND PATTERN (Unit: mm)

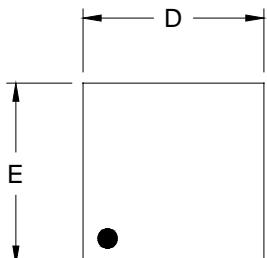
Symbol	Dimensions In Millimeters		
	MIN	MOD	MAX
A	0.320	-	0.400
A1	0.000	-	0.050
A2	0.102 REF		
b	0.150	-	0.250
b1	0.070 REF		
D	0.700	-	0.900
E	0.700	-	0.900
D1	0.150	-	0.350
E1	0.150	-	0.350
L	0.170	-	0.270
L1	0.090 REF		
e	0.500 BSC		
k	0.200 REF		
eee	0.050		

NOTE: This drawing is subject to change without notice.

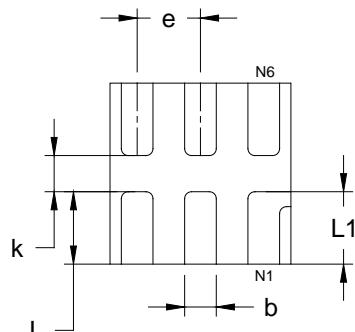
PACKAGE INFORMATION

PACKAGE OUTLINE DIMENSIONS

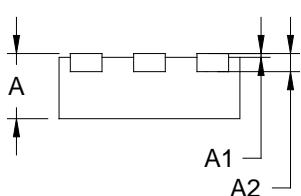
XTDFN-1x1-6L



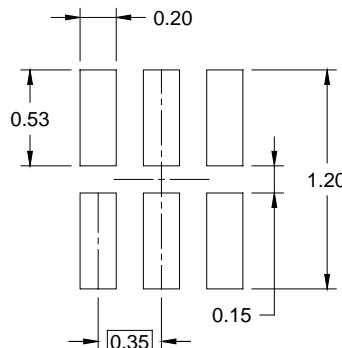
TOP VIEW



BOTTOM VIEW



SIDE VIEW



RECOMMENDED LAND PATTERN (Unit: mm)

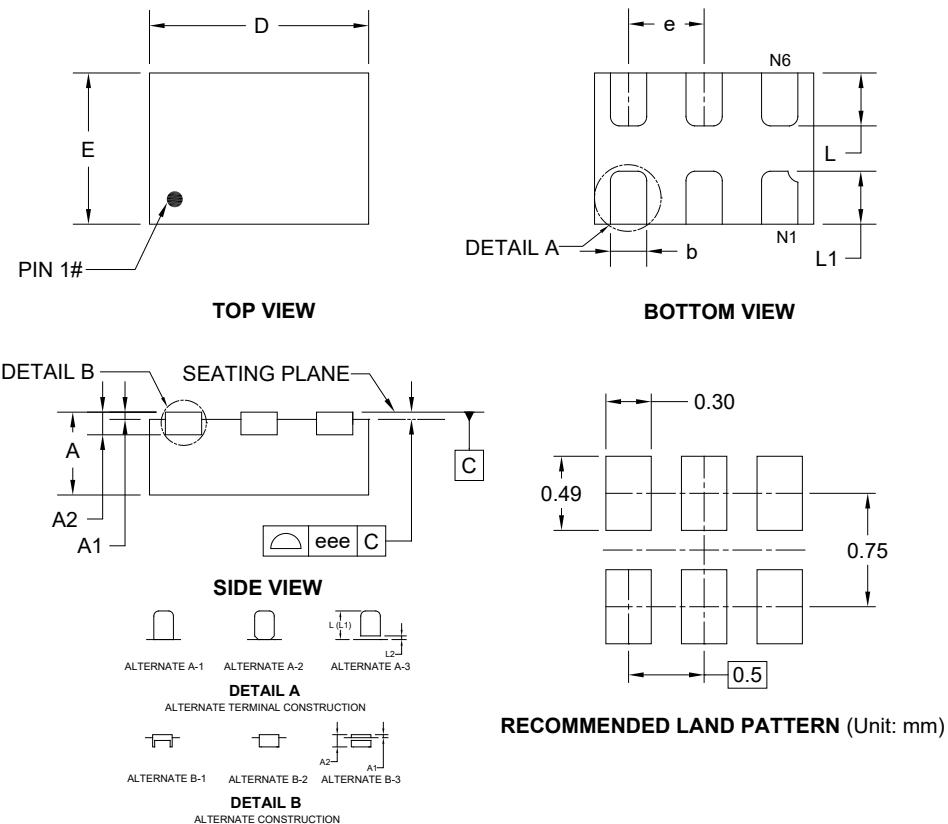
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.320	0.400	0.013	0.016
A1	0.000	0.050	0.000	0.002
A2	0.100 REF		0.004 REF	
D	0.950	1.050	0.037	0.041
E	0.950	1.050	0.037	0.041
k	0.150 MIN		0.006 MIN	
b	0.120	0.230	0.005	0.009
e	0.350 TYP		0.014 TYP	
L	0.350	0.450	0.014	0.018
L1	0.350	0.450	0.014	0.018

NOTE: This drawing is subject to change without notice.

PACKAGE INFORMATION

PACKAGE OUTLINE DIMENSIONS

UTDFN-1.45x1-6AL



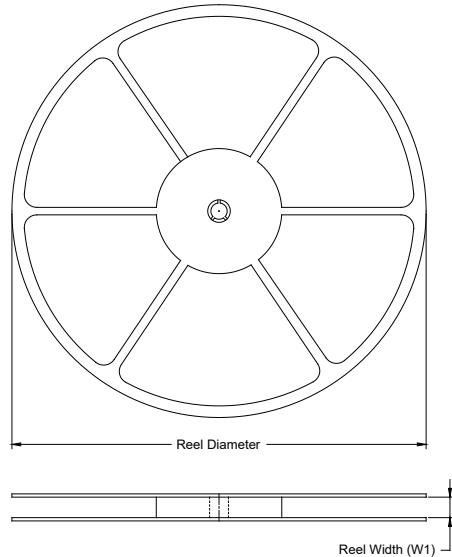
Symbol	Dimensions In Millimeters		
	MIN	MOD	MAX
A	0.450	-	0.600
A1	-0.004	-	0.050
A2	0.150 REF		
b	0.150	-	0.300
D	1.374	-	1.526
E	0.924	-	1.076
e	0.500 BSC		
L	0.250	-	0.450
L1	0.250	-	0.500
L2	0.000	-	0.100
eee	0.050		

NOTE: This drawing is subject to change without notice.

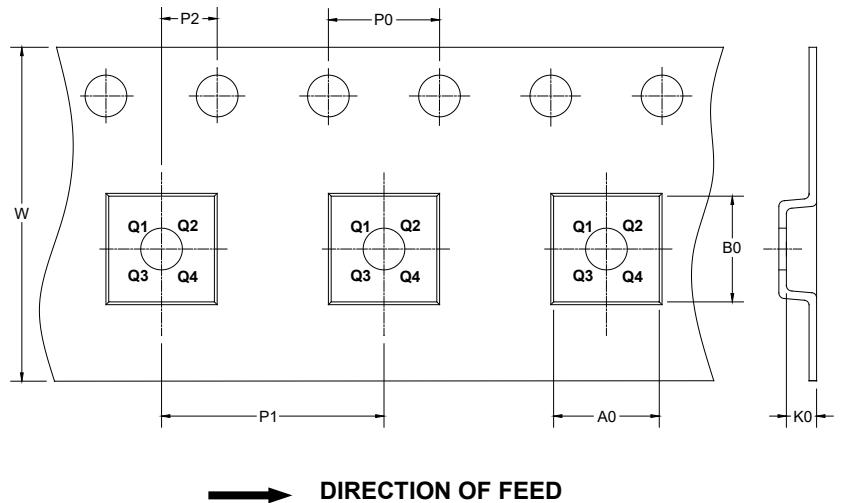
PACKAGE INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



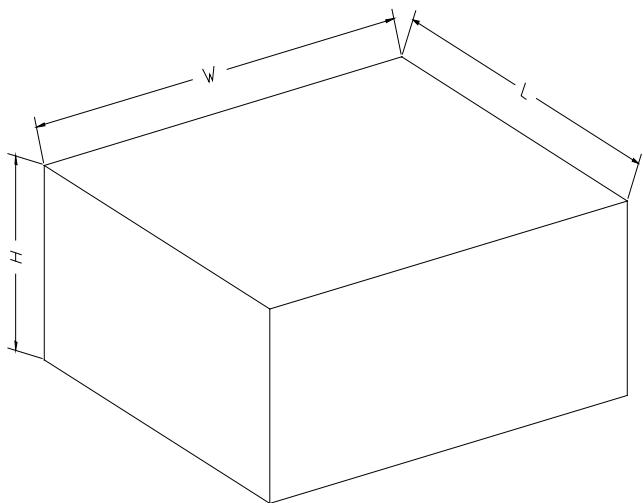
NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SC70-5	7"	9.5	2.40	2.50	1.20	4.0	4.0	2.0	8.0	Q3
SOT-23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3
XTDFN-0.8×0.8-4AL	7"	9.5	0.94	0.94	0.50	4.0	2.0	2.0	8.0	Q3
XTDFN-1×1-6L	7"	9.5	1.16	1.16	0.50	4.0	2.0	2.0	8.0	Q3
UTDFN-1.45×1-6AL	7"	9.5	1.15	1.60	0.75	4.0	4.0	2.0	8.0	Q1

PACKAGE INFORMATION

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18

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